

# Product/Process Change Notification

N° 2021-206-A

Dear customer,

please find attached our Infineon Technologies AG PCN:

## Introduction of an additional wafer production and wafer test location at Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for products TLE7258LE, TLE8457xLE, TLS115x0LD

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2023-03-29.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change." Notwithstanding the aforesaid individual agreements shall prevail.

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG

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[Management Board](#) Jochen Hanebeck (CEO), Constanze Hufenbecher, Dr. Sven Schneider, Andreas Urschitz, Dr. Rutger Wijburg

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# Product/Process Change Notification

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## Products affected

Please refer to attached affected product list PCN\_2021-206-A\_[customer-no].pdf

## Detailed change information

**Subject:** Introduction of an additional wafer production and wafer test location at Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for products TLE7258LE, TLE8457xLE, TLS115xOLD

**Reason/Motivation:** Capacity expansion wafer process and wafer test:  
 Due to continuously raising demand for Infineon automotive products exceeding the capacity in Villach we have to extend wafer production to the well known location Kulim  
 Further loading of Kulim wafer test site within Infineon frontend test cluster

Description	Old	New
<b>PROCESS - WAFER PRODUCTION: Move all or parts of production to a different wafer fab site.</b>	Infineon Technologies Austria AG, Villach, Austria	Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia AND Infineon Technologies Austria AG, Villach, Austria
<b>TEST FLOW: Move of all or part of electrical wafer test and/or final test to a different test site.</b>	Infineon Technologies Austria AG, Villach, Austria	Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia AND Infineon Technologies Austria AG, Villach, Austria

## Product identification

No change in SP ordering number.

## Anticipated impact of change

Based on the qualification performed, Infineon does not expect any negative impact on quality, function and reliability. No change in form, fit and function expected.

DeQuMa-ID(s): SEM-PW-13 / SEM-TF-01

## Attachments

PCN\_2021-206-A\_[customer-no].pdf affected product list

## Product/Process Change Notification

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### Time schedule

Final qualification report	available
First samples available	on request
Intended start of delivery [1]	2023-08-16

If you have any questions, please do not hesitate to contact your local sales office.

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Affected products sold to FUTURE ELECTRONICS INC. (4000624)

Sales name	SP number	OPN	Package	Customer part number
TLE8457BLE	SP001376018	TLE8457BLEXUMA1	PG-TSON-8-1	TLE8457BLEXUMA1